

FDD7030BL/FDU7030BL

30V N-Channel PowerTrench® MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$, fast switching speed and extremely low $R_{DS(ON)}$ in a small package.

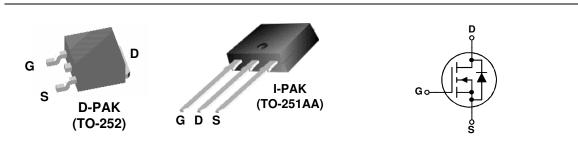
Applications

- DC/DC converter
- Motor Drives

Features

• 56 A, 30 V
$$\begin{array}{l} R_{DS(ON)} = 9.5 \ m\Omega \ @ \ V_{GS} = 10 \ V \\ R_{DS(ON)} = 13 \ m\Omega \ @ \ V_{GS} = 4.5 \ V \\ \end{array}$$

- Low gate charge
- Fast Switching
- High performance trench technology for extremely low R_{DS(ON)}



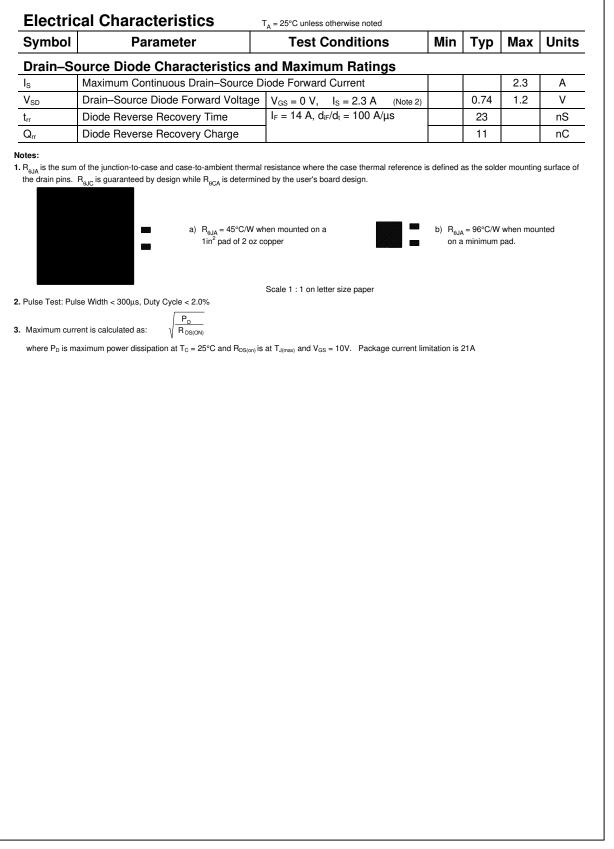
Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter			Ratings			Units
V _{DSS}	Drain-Source Voltage				30		V
V _{GSS}	Gate-Source Voltage				±20		V
ID	Continuous Drain Cur	rent @T _c =25°C	(Note 3)		56		Α
		@T _A =25°C	(Note 1a)		14		
		Pulsed	(Note 1a)		100		
> _D	Power Dissipation	@T _c =25°C	(Note 3)		60		W
		@T _A =25°C	(Note 1a)		2.8		
		@T _A =25°C	(Note 1b)		1.3		
Tj, T _{stg}	Operating and Storage Junction Temperature Range		-5	5 to +175		°C	
Therma	al Characteristic	s					
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)		2.5			°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)		45				
$R_{\theta JA}$			(Note 1b)		96		
Packag	e Marking and	Ordering Info	ormatior				
U		Ť.	ackage	Reel Size	Tape width	Qua	antity

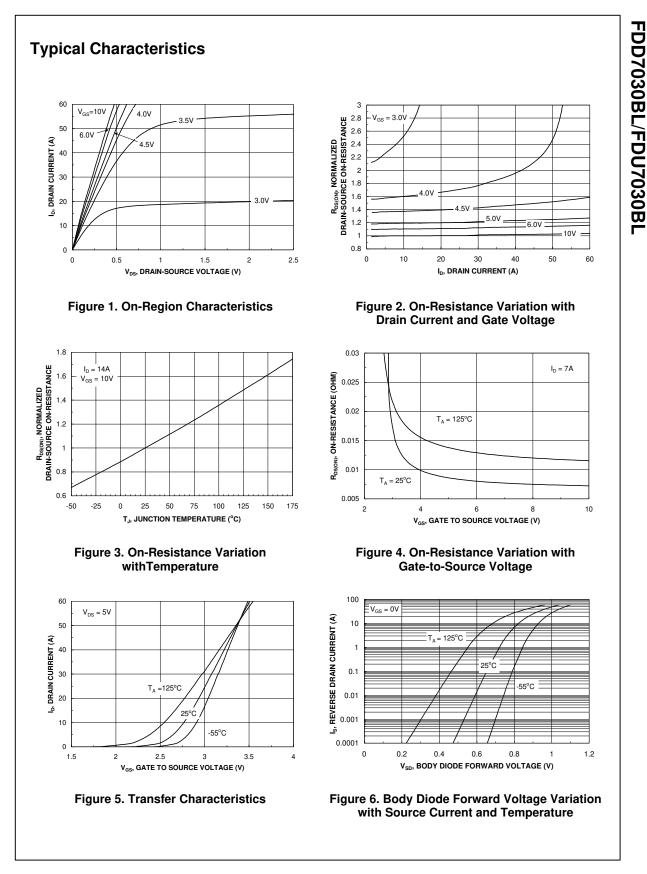
June 2003

	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	ource Avalanche Ratings (Not	e 2)			•	•
E _{AS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$, $I_{D} = 14 \text{ A}$			174	mJ
I _{AS}	Drain-Source Avalanche Current				14	Α
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		26		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)	•	•		,	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	1	1.8	3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		-5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = 10 \ V, & I_D = 14 \ A \\ V_{GS} = 4.5 \ V, & I_D = 12 \ A \\ V_{GS} = 10 \ V, & I_D = 14 \ A, T_J = 125^\circ C \end{array} $		7.5 9.6 11	9.5 13 16	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS}=10~V, \qquad V_{DS}=5~V$	50			А
g _{FS}	Forward Transconductance	$V_{\text{DS}} = 10 \text{ V}, \qquad I_{\text{D}} = 14 \text{ A}$		56		S
Dvnamio	Characteristics					
C _{iss}	Input Capacitance			1425		pF
C _{oss}	Output Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		350		pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		150		pF
R _G	Gate Resistance	$V_{OSC} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		1.3		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time			11	20	ns
tr	Turn–On Rise Time	$V_{DD} = 15 V, I_D = 1 A,$		9	18	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		31	50	ns
t _f	Turn-Off Fall Time			13	23	ns
Qg	Total Gate Charge			14	20	nC
	Gate-Source Charge	$V_{DS} = 15V,$ $I_{D} = 14 \text{ A},$ $V_{GS} = 5 \text{ V}$		4		nC
Q _{gs}	Gate-Drain Charge	VGS – J V		5		nC

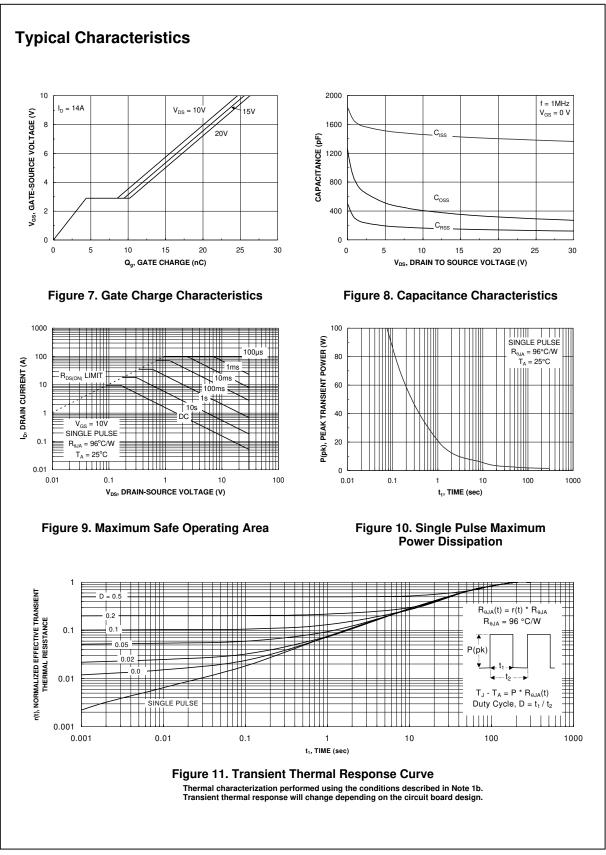
FDD7030BL/FDU7030BL



FDD7030BL/FDU7030BL Rev. B(W)



FDD7030BL/FDU7030BL Rev. B(W)



FDD7030BL/FDU7030BL

FDD7030BL/FDU7030BL Rev. B(W)

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	FACT Quiet Series™	LittleFET™	Power247™	SuperSOT™-6
ActiveArray™	FAST®	MICROCOUPLER™	PowerTrench [®]	SuperSOT™-8
Bottomless™	FASTr™	MicroFET™	QFET [®]	SyncFET™
CoolFET™	FRFET™	MicroPak™	QS™	TinyLogic [®]
CROSSVOLT™	GlobalOptoisolator™	MICROWIRE™	QT Optoelectronics [™]	TINYOPTO™
DOME™	GTO™່	MSX™	Quiet Series [™]	TruTranslation™
EcoSPARK™	HiSeC™	MSXPro™	RapidConfigure™	UHC™
E ² CMOS [™]	I ² C [™]	OCX™	RapidConnect™	UltraFET [®]
EnSigna™	ImpliedDisconnect™	OCXPro™	SILENT SWITCHER®	VCX™
FACT™	ISOPLANAR™	OPTOLOGIC[®]	SMART START™	
Across the boar	d. Around the world.™	OPTOPLANAR™	SPM™	
The Power Fran		PACMAN™	Stealth™	
Programmable A		POP™	SuperSOT™-3	

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Product Status	Definition
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
	Formative or In Design First Production Full Production